

EVAL-M1-IR2214 User Guide

1200 V junction-isolation gate driver IR2214SS evaluation board

About this document

Scope and purpose

This user guide provides an overview of the evaluation board EVAL-M1-IR2214 including its main features, key components and design details. The user guide describes how to run a brushless direct current (BLDC) motor with the evaluation board, and verifies the board by a double-pulse test for a higher power rating.

Intended audience

This document is intended for all technical specialists who have a knowledge of motor control and high-power electronics converters. The board should be used under laboratory conditions.

Evaluation board

The board EVAL-M1-IR2214 is designed to evaluate the 1200 V junction-isolation gate driver IR2214SS along with the 1200 V/50 A EconoPIM™3 module FP50R12KT4G.

This board will be used during design-in, for evaluation and measurement of characteristics, and proof of data sheet specifications.

Note: PCB and auxiliary circuits are NOT optimized for final customer design.

Ordering information

| Base part number | Package | Standard pack | | Orderable part number |
|------------------|------------|---------------|----------|-----------------------|
| | | Form | Quantity | |
| EVAL-M1-IR2214 | MADK EVAL | Boxed | 1 | EVALM1IR2214TOBO1 |
| IR2214SS | SSOP24 | Tape & Reel | 2000 | IR2214SSTRPBF |
| EVAL-M1-101T | MADK EVAL | Container | 1 | EVALM1101TTOBO2 |
| FP50R12KT4G | AG-ECONO3 | Tray | 10 | FP50R12KT4GBOSA1 |
| ICE5QSAG | PG-DSO-8 | Tape & Reel | 2500 | ICE5QSAGXUMA1 |
| IMBF170R1K0M1 | PG-TO263-7 | Tape & Reel | 1000 | IMBF170R1K0M1XTMA1 |
| IFX25001TFV50 | PG-TO252-3 | Tape & Reel | 2500 | IFX25001TFV50ATMA1 |

Important notice

Important notice

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Safety precautions

Safety precautions

Note: Please note the following warnings regarding the hazards associated with development systems.

Table 1 Safety precautions

| | |
|-------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|  | <p>Warning: The DC link potential of this board is up to 800 VDC. When measuring voltage waveforms by oscilloscope, high voltage differential probes must be used. Failure to do so may result in personal injury or death.</p> |
|  | <p>Warning: The evaluation or reference board contains DC bus capacitors which take time to discharge after removal of the main supply. Before working on the drive system, wait five minutes for capacitors to discharge to safe voltage levels. Failure to do so may result in personal injury or death. Darkened display LEDs are not an indication that capacitors have discharged to safe voltage levels.</p> |
|  | <p>Warning: The evaluation or reference board is connected to the grid input during testing. Hence, high-voltage differential probes must be used when measuring voltage waveforms by oscilloscope. Failure to do so may result in personal injury or death. Darkened display LEDs are not an indication that capacitors have discharged to safe voltage levels.</p> |
|  | <p>Warning: Remove or disconnect power from the drive before you disconnect or reconnect wires, or perform maintenance work. Wait five minutes after removing power to discharge the bus capacitors. Do not attempt to service the drive until the bus capacitors have discharged to zero. Failure to do so may result in personal injury or death.</p> |
|  | <p>Caution: The heat sink and device surfaces of the evaluation or reference board may become hot during testing. Hence, necessary precautions are required while handling the board. Failure to comply may cause injury.</p> |
|  | <p>Caution: Only personnel familiar with the drive, power electronics and associated machinery should plan, install, commission and subsequently service the system. Failure to comply may result in personal injury and/or equipment damage.</p> |
|  | <p>Caution: The evaluation or reference board contains parts and assemblies sensitive to electrostatic discharge (ESD). Electrostatic control precautions are required when installing, testing, servicing or repairing the assembly. Component damage may result if ESD control procedures are not followed. If you are not familiar with electrostatic control procedures, refer to the applicable ESD protection handbooks and guidelines.</p> |
|  | <p>Caution: A drive that is incorrectly applied or installed can lead to component damage or reduction in product lifetime. Wiring or application errors such as undersizing the motor, supplying an incorrect or inadequate AC supply, or excessive ambient temperatures may result in system malfunction.</p> |
|  | <p>Caution: The evaluation or reference board is shipped with packing materials that need to be removed prior to installation. Failure to remove all packing materials that are unnecessary for system installation may result in overheating or abnormal operating conditions.</p> |

Table of contents

About this document..... 1

Important notice 2

Safety precautions..... 3

Table of contents 4

1 The board at a glance..... 5

1.1 Delivery content5

1.2 Block diagram.....5

1.3 Main features6

1.4 Board parameters and technical data7

2 System and functional description 8

2.1 Commissioning.....8

2.1.1 Running a BLDC motor.....8

2.1.2 Double-pulse test8

2.2 Description of the functional blocks.....10

2.2.1 Inrush current limitation.....10

2.2.2 DC-link voltage measurement10

2.2.3 EconoPIM™3 FP50R12KT4G.....11

2.2.4 Drive circuit with the IR2214SS.....11

2.2.5 Current feedback.....12

2.2.6 NTC-thermistor configuration13

2.2.7 Auxiliary power supply.....13

2.3 iMOTION™ development tool and software.....14

2.3.1 MCEWizard setup.....14

2.3.2 MCEDesigner setup17

3 System design.....18

3.1 Schematics18

3.2 Layout19

3.2.1 Layout details19

3.2.2 Layout guidelines20

3.3 Bill of material21

3.4 Connector details21

4 System performance22

4.1 Test results running a BLDC motor.....22

4.2 Test results of the double-pulse test25

5 References and appendices26

5.1 Abbreviations and definitions.....26

5.2 References26

Revision history.....27

The board at a glance

1 The board at a glance

The evaluation board EVAL-M1-IR2214 contains the gate driver ICs IR2214SS, the EconoPIM™3 module FP50R12KT4G, the bus capacitors and peripheral circuits.

1.1 Delivery content

The complete board EVAL-M1-IR2214 is delivered with daughter board for auxiliary power supplies included.

1.2 Block diagram

Figure 1 shows a typical application diagram of the EVAL-M1-IR2214 for driving a BLDC motor. All the power circuits are included in the EVAL-M1-IR2214. The rectifier, brake and inverter are combined in the power integration module (PIM) FP50R12KT4G. The daughter board provides the power supplies for both gate drivers and controller board.

The system adopts the single-shunt configuration, which is prevalent for current BLDC motor drive applications.

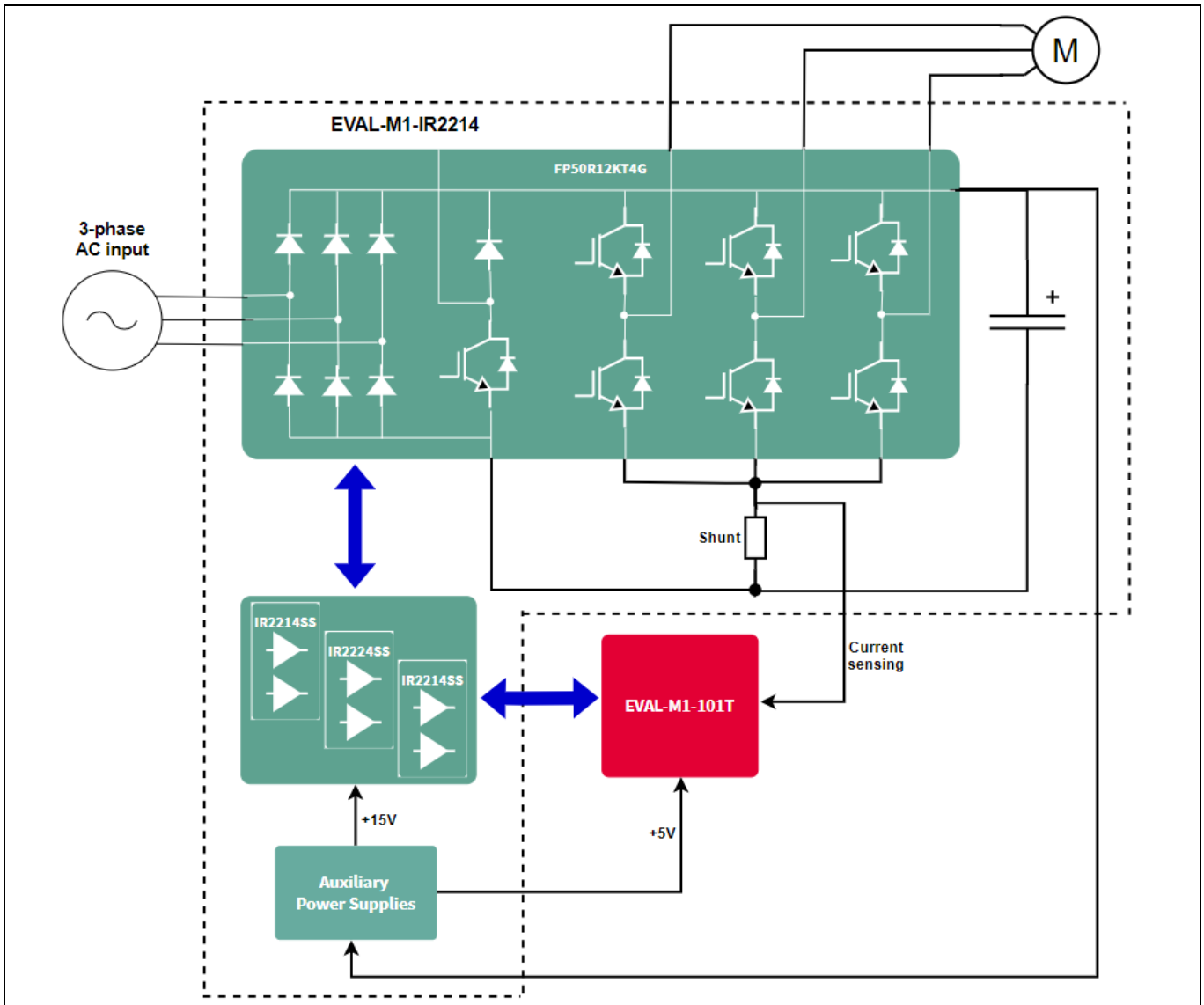


Figure 1 Typical application block diagram of the EVAL-M1-IR2214

EVAL-M1-IR2214 User Guide

1200 V junction-isolation gate driver IR2214SS evaluation board

The board at a glance

The functional blocks of the EVAL-M1-IR2214 are presented in Figure 2 and Figure 3.

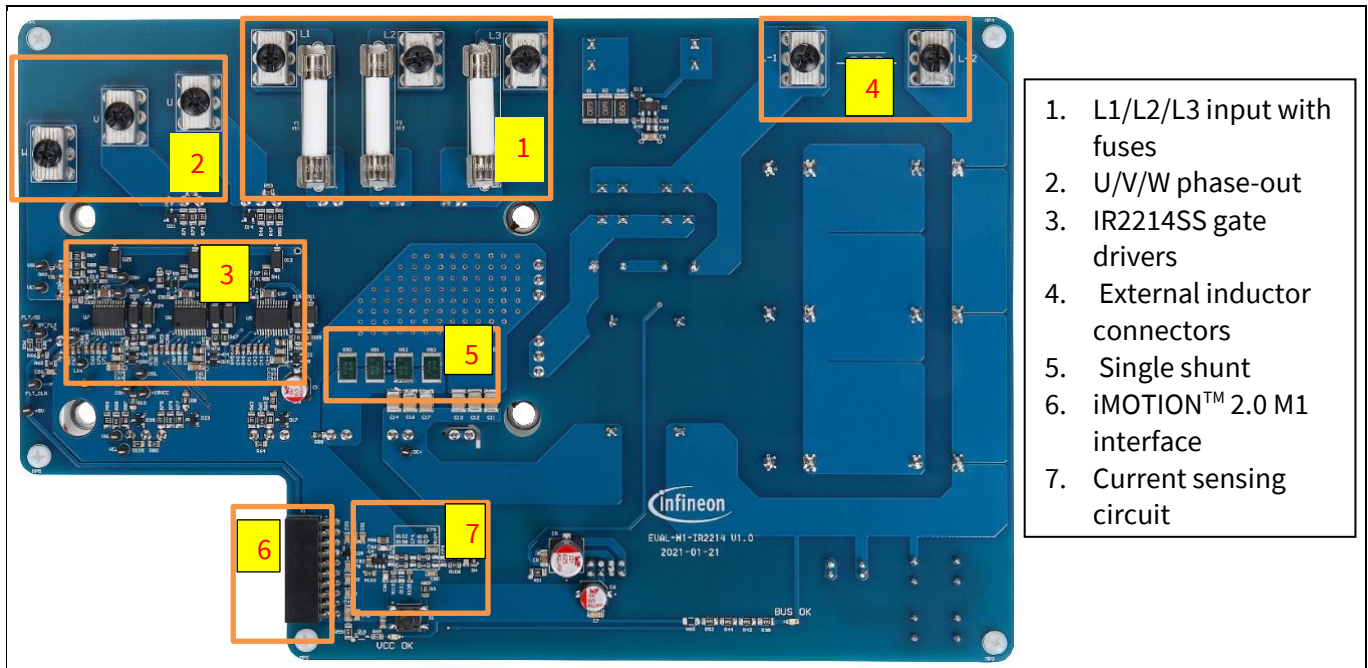


Figure 2 Functional blocks of the EVAL-M1-IR2214 – top view

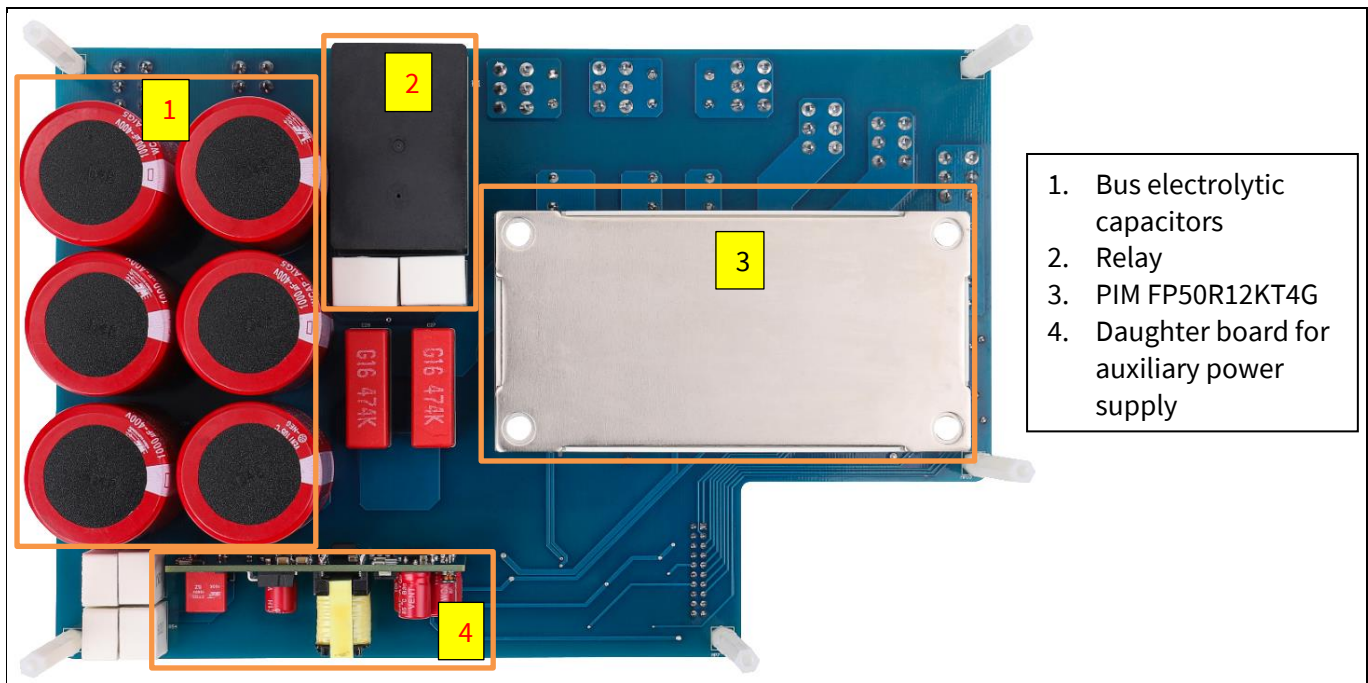


Figure 3 Functional blocks of the EVAL-M1-IR2214 – bottom view

1.3 Main features

Main features of the EVAL-M1-IR2214 include:

- 380 V_{AC} three-phase input with fuses on the board providing basic electrical protection
- Inrush current limit circuit included for a safer power-on

The board at a glance

- Compact design with the EconoPIM™3 FP50R12KT4G which combines the rectifier, brake and inverter in one package
- Optimized system performance with the IR2214SS which includes enhanced features, such as desaturation protection, soft overcurrent shutdown, two-stage turn-on output, separate sink/source output, etc.
- +15 V and +5 V auxiliary power supplies on the board
- M1 interface compatible with the iMOTION™ controller board

1.4 Board parameters and technical data

The key specifications of the EVAL-M1-IR2214 are listed in Table 2.

Table 2 EVAL-M1-IR2214 board specification

| Parameter | Symbol | Conditions | Value | | | Unit |
|--------------------------------|-----------|---------------------------------------------|-------|------|-----|----------|
| | | | min | nom | max | |
| Input | | | | | | |
| Input voltage | V_{IN} | Line voltage, three-phase input | | | 480 | V_{AC} |
| Input current | I_{IN} | Phase current | | | 15 | A |
| Output | | | | | | |
| Output current | I_{OUT} | RMS phase-out current | | | 23 | A |
| Output power | P_{OUT} | With adequate cooling method | | | 10 | kW |
| Over-current protection | | Peak phase-out current defined in MCEWizard | | | 50 | A |
| Thermal protection | | | | | | |
| NTC over-temperature threshold | V_{TH} | Configuration in MCEWizard | 1.84 | 4.14 | | V |
| | | | 100 | 25 | | °C |
| Switching frequency | | | | | | |
| Inverter frequency | F_{SW} | | | 8 | | kHz |
| Auxiliary power supply | | | | | | |
| Gate driver power supply | VCC | | | 15 | | V |
| Controller power supply | | | | 5 | | V |
| System environment | | | | | | |
| Ambient temperature | | With adequate cooling method | | 25 | | °C |
| PCB characteristics | | | | | | |
| Dimensions | | Length | | 245 | | mm |
| | | Width | | 160 | | mm |
| | | Height | | 65 | | mm |
| Layer | | | | 2 | | |
| PCB thickness | | | | 2 | | mm |
| Copper thickness | | | | 2 | | oz. |
| Weight | | Weight of the entire PCB assembly | | 1240 | | g |
| Material | | FR-4, RoHS-compliant | | | | |

2 System and functional description

2.1 Commissioning

2.1.1 Running a BLDC motor

By connecting the iMOTION™2.0 controller board EVAL-M1-101T through an M1 interface, the power board EVAL-M1-IR2214 can run a BLDC motor. The system connection is shown in Figure 4, and the test results are recorded in section 4.1.

Caution: *The required, adequate cooling method should be used to prevent the PIM from overheating, since it is not provided in the scope of delivery.*

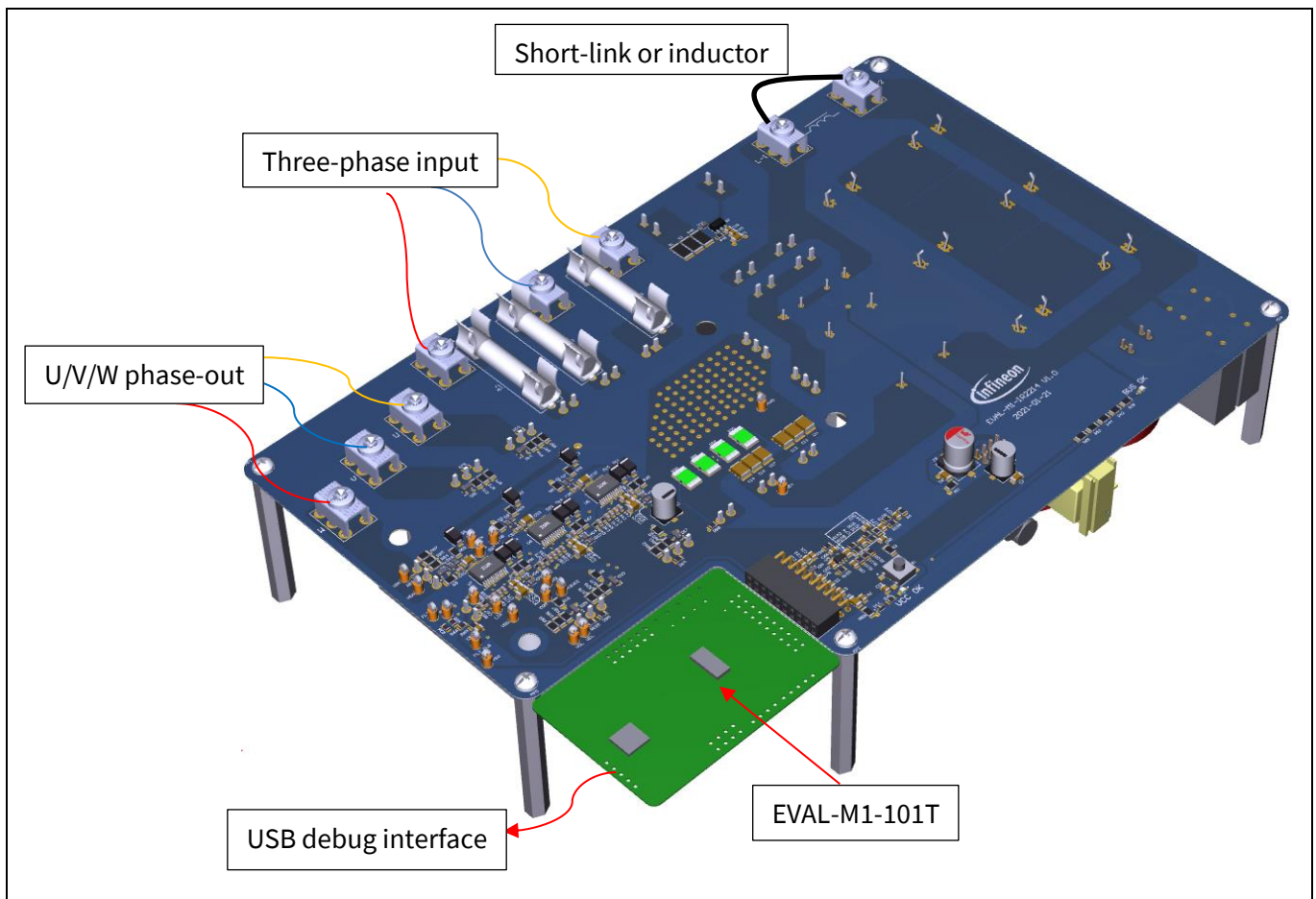


Figure 4 The system connection for running a BLDC motor

2.1.2 Double-pulse test

The double-pulse test is applied to check the robustness of the gate driver IR2214SS under extreme working conditions. Some critical data such as negative V_s and V_{SS} transient should be checked whether they are still within the specification. The worst condition occurs when the double-pulse test is performed on the high-side switch. The test method is illustrated in Figure 5.

Note: The cooling method is not needed for double-pulse test.

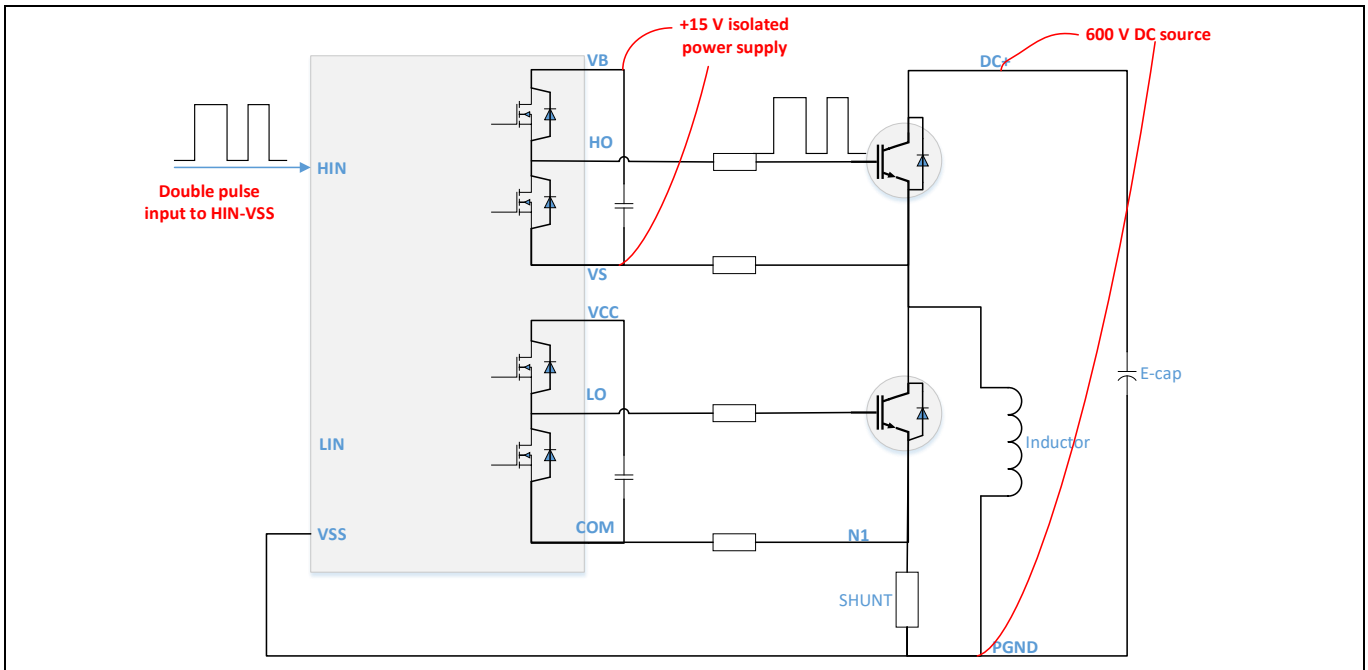


Figure 5 Double-pulse test on the high-side switch

A DC source is used to charge the bus electrolytic capacitors. The positive output of the DC source is connected to the 'DC+' test point, whereas the negative output to the power ground 'PGND' test point on the EVAL-M1-IR2214 board. The double-pulse test is taken on the W-phase since it has the largest ground loop. The test setup is shown in Figure 6, and the test results including the minus V_s are offered in section 0.

Caution: 1. Check the connections according to the right polarities of the DC source.

2. The bus voltage should gradually rise if the DC source has no inrush current limitation.

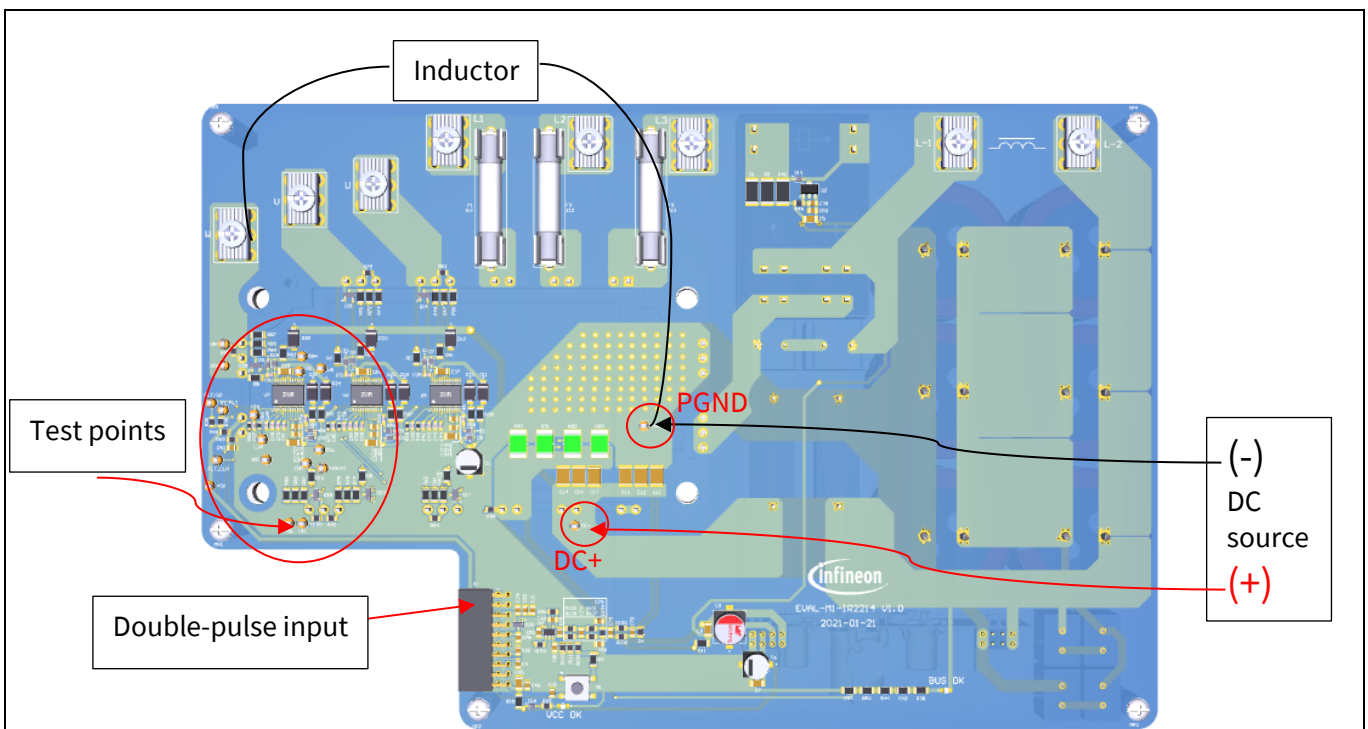


Figure 6 Double-pulse test system setup

2.2 Description of the functional blocks

This chapter covers the hardware design of the EVAL-M1-IR2214 in detail. The users can modify the circuit or re-select the component values based on the actual applications in the field.

2.2.1 Inrush current limitation

To protect input fuses, rectifier and bus capacitors from large inrush current during power-on, the inrush current limitation circuit is usually needed, see Figure 7.

At the beginning of power-on, the relay is open and the bus capacitors are charged through R56 and R57. When the +15 V power supply is established (after around 100 mS), the relay is closed to take over the charge current.

The R1, R2 and R40 are used to regulate the +15 V to +12 V, with which the relay works.

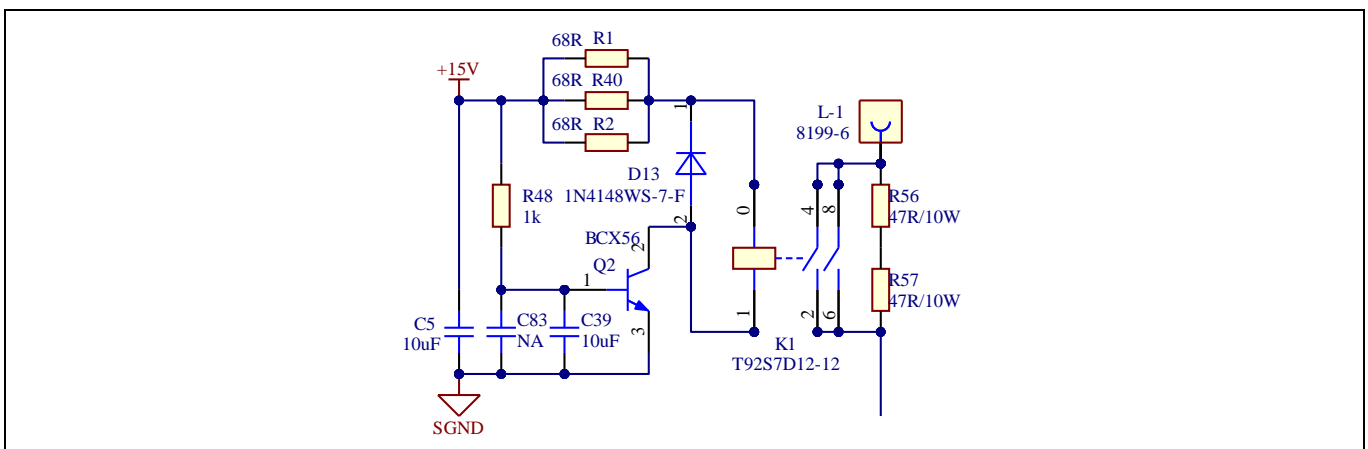


Figure 7 Inrush current limitation circuit

2.2.2 DC-link voltage measurement

The bus capacitors should be large enough to stabilize the bus voltage. The resistors R37, R43, R51 and R54 are used for balancing the voltage on the electrolytic capacitors in series, see Figure 8.

Note: The resistor R55 is not soldered on the EVAL-M1-IR2214 main board. There is a 13.3 kΩ pull-down resistor located on the EVAL-M1-101T controller board.

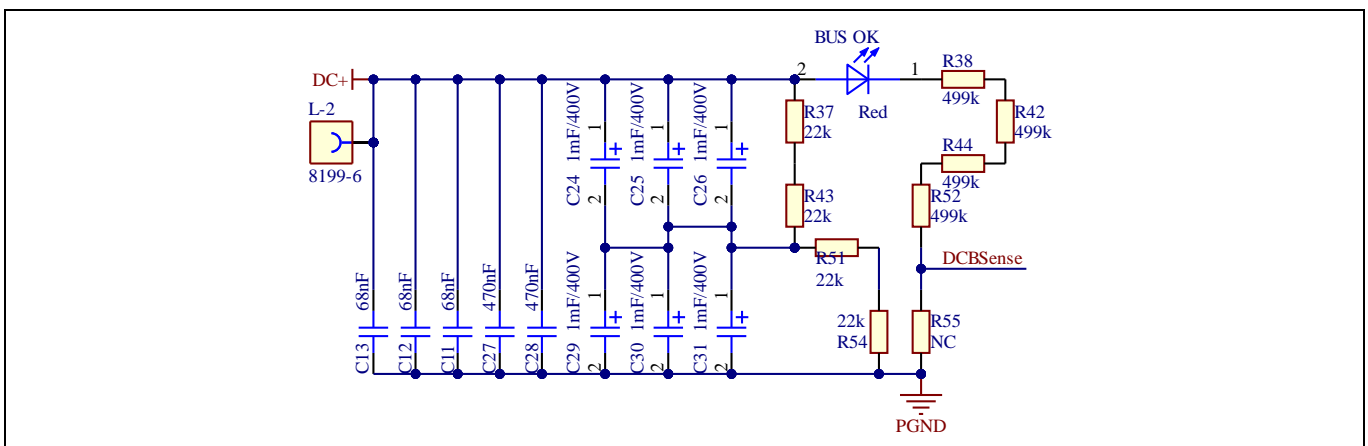


Figure 8 Bus capacitor configuration and DC bus sensing

2.2.3 EconoPIM™3 FP50R12KT4G

The EconoPIM™3 FP50R12KT4G combines the three-phase rectifier, brake, inverter and NTC function blocks in one package. The internal structure of the FP50R12KT4G is shown in Figure 9.

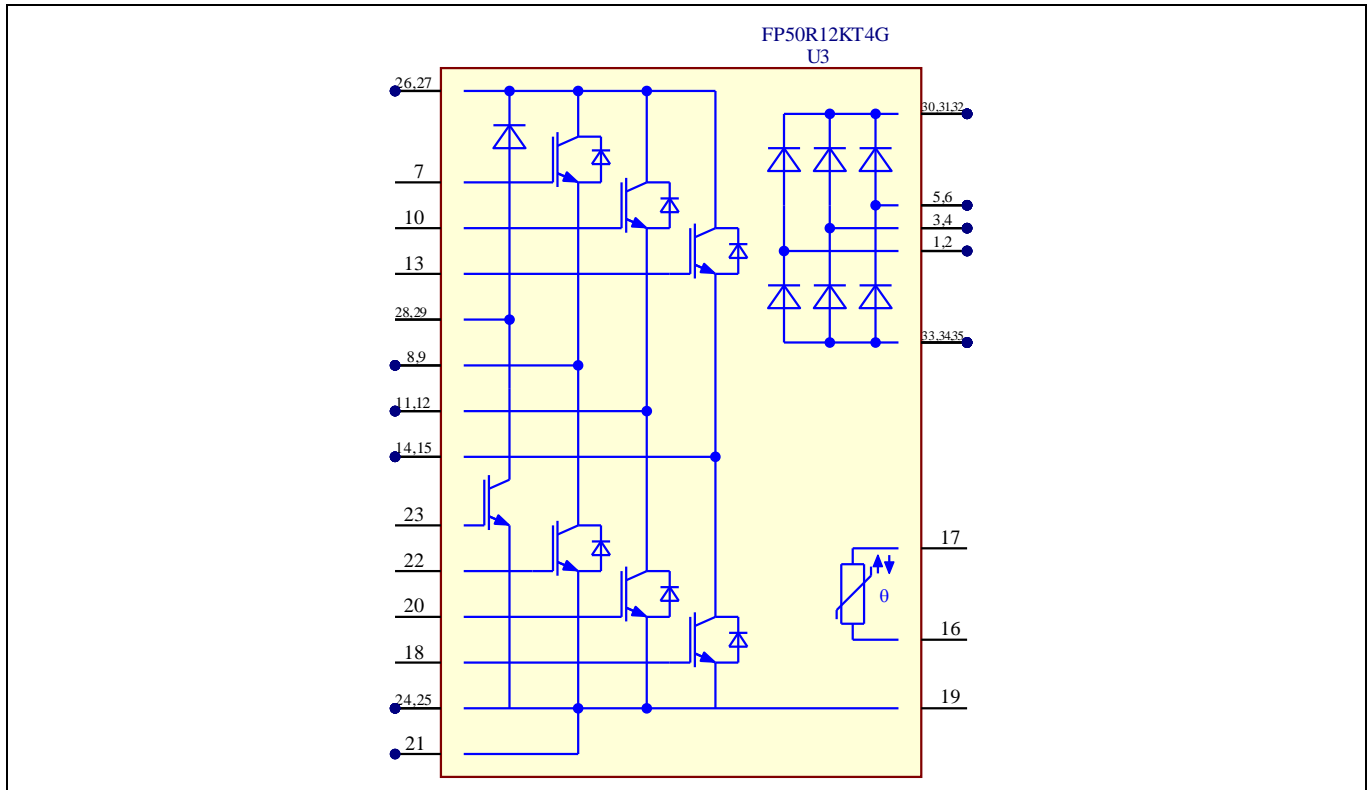


Figure 9 Internal structure of the FP50R12KT4G

2.2.4 Drive circuit with the IR2214SS

There are three half-bridge gate drivers IR2214SS used for the inverter drive. The configuration of the IR2214SS is depicted in Figure 10.

The desaturation protection is a key feature of the IR2214SS. The IGBT switching would cause the overshoot/undershoot at the desaturation detection pins DSH/DSL. It is necessary to clamp the DSH/DSL to the power supply $V_B/+15\text{ VCC}$ and ground reference V_S/COM individually, to prevent IC damage. The clamping diodes should have small leakage current at high temperature, like the BAS16J selected herein.

To suppress the voltage spikes between the V_{SS} and COM caused by the IGBT switching, a small resistor R_6 is added between the COM and the low-side IGBT emitter N_1 . The resistor R_5 is needed to balance the gate resistance of both the high-side and low-side drive loops.

The FLT_CLR , SY_FLT , FAULT/SD pins of the three IR2214SS ICs are individually connected together. Any fault reported from one IR2214SS will shut down the other two. The MCU can also control the three gate drivers synchronously.

If the desaturation protection is triggered, the FAULT/SD (pin 5) of IR2214SS will be pulled low and the drive outputs are disabled. There should be an active high pulse at the FLT_CLR (pin 3) to clear the fault and release the IC from protection. On this EVAL-M1-IR2214 board, the users have to press the push-button S_1 to re-enable the IC.

2.2.6 NTC-thermistor configuration

The FP50R12KT4G combines a negative-temperature-coefficient (NTC) thermistor internally. The NTC thermistor-temperature curve is shown in Figure 12.

The NTC-thermistor resistance is 5 kΩ@25°C and 493 Ω@100°C.

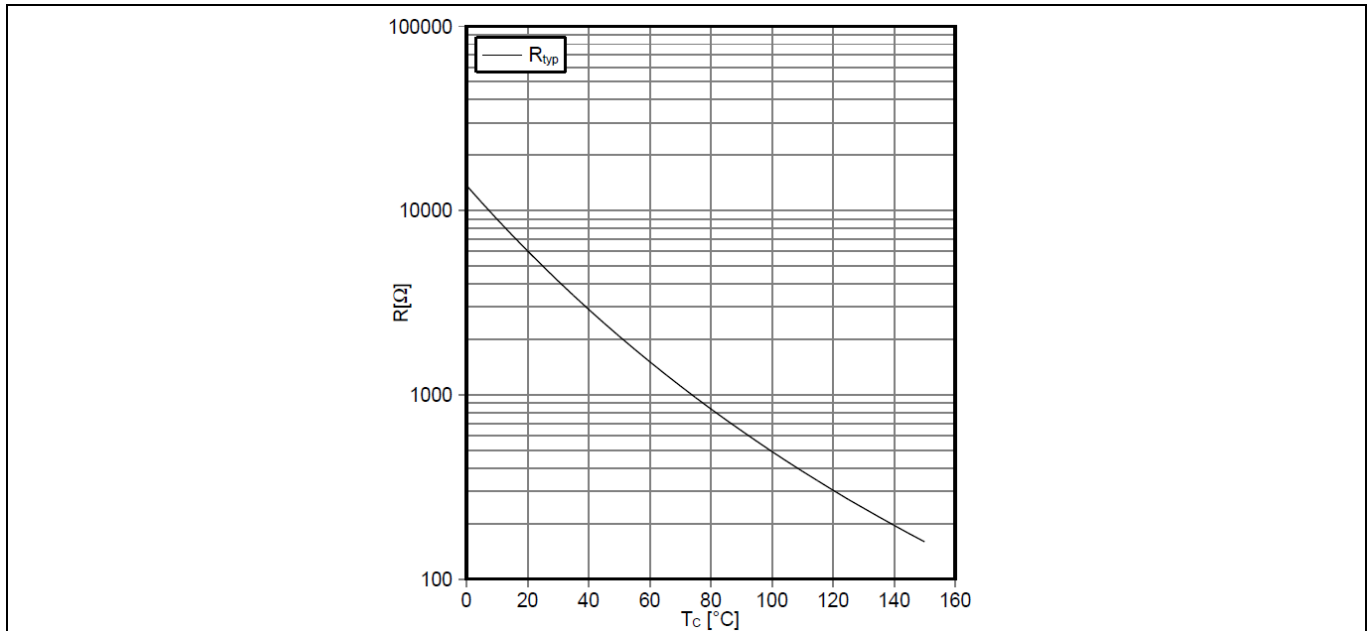


Figure 12 The NTC thermistor-temperature characteristic (typical)

There is a 4.87 kΩ pull-up resistor already located on the EVAL-M1-101T controller board. As the NTC-thermistor configuration in Figure 13, the sensing voltage V_{TH} equals 4.14 V@25°C and 1.84 V@100°C. In MCEWizard the NTC-thermistor over-temperature voltage threshold is set to 1.84 V to protect the PIM from temperatures exceeding 100 °C.

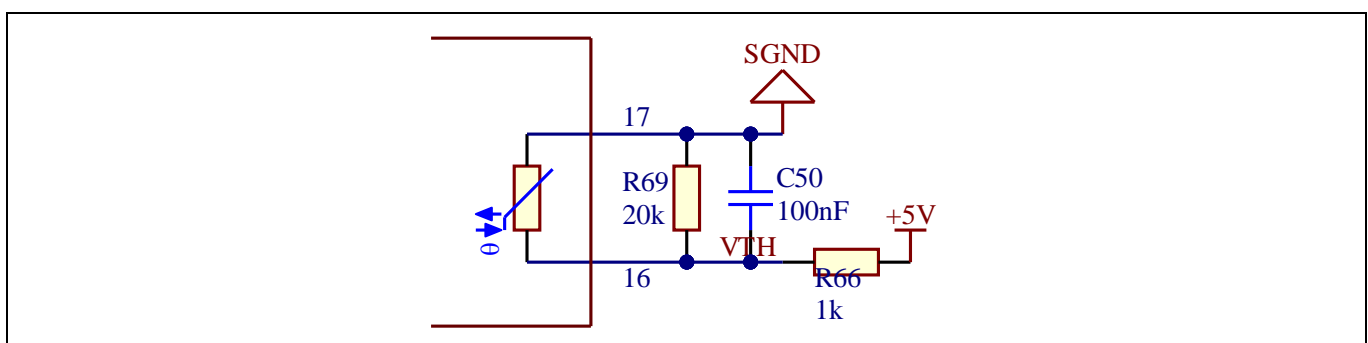


Figure 13 NTC-thermistor configuration

2.2.7 Auxiliary power supply

The auxiliary power supply circuit is located in the daughter board. It adopts the quasi-resonant flyback controller ICE5QSAG and CoolSiC™ 1700 V SiC MOSFET, IMF170R1k0M1, in a TO-263-7 package. The primary ground, and secondary +15 V and +5 V reference grounds are separated in the daughter board, but connected as a same net on the main board.

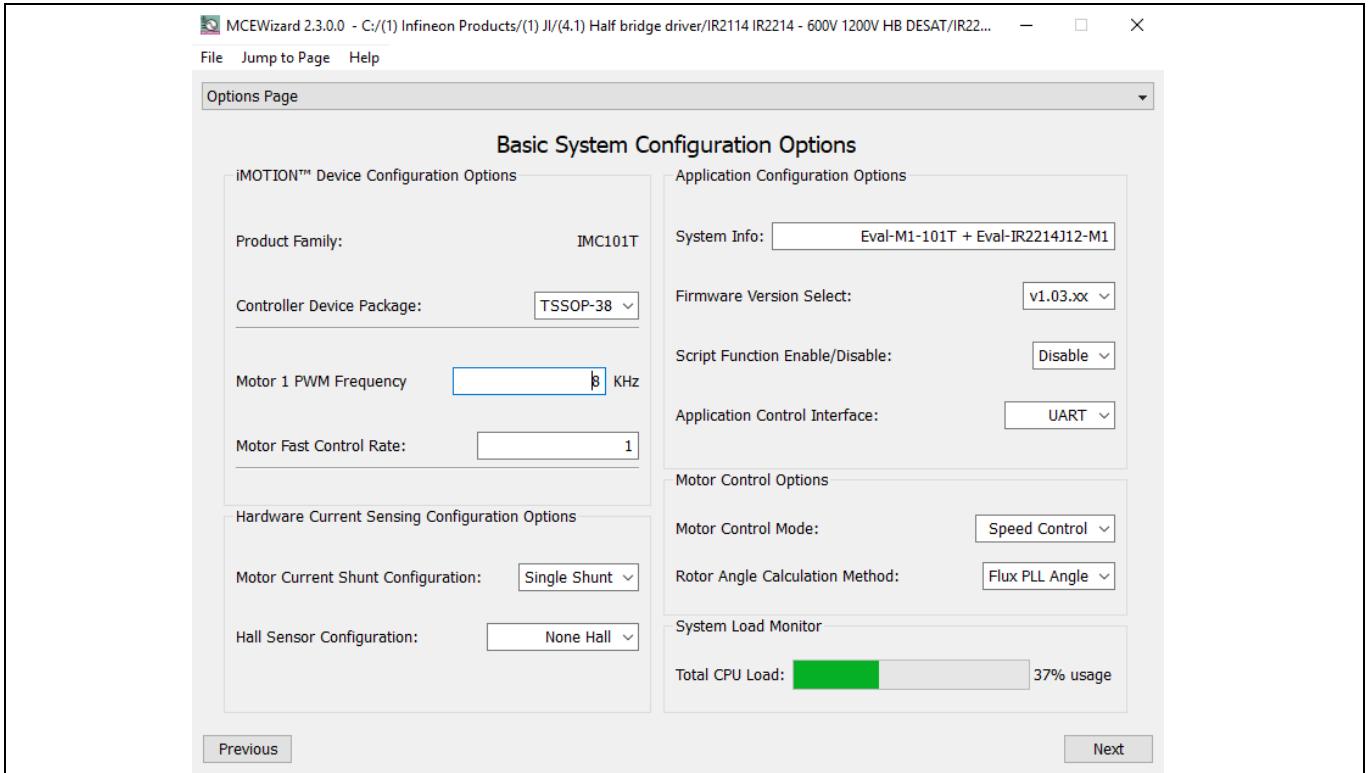


Figure 15 Basic system configuration in MCEWizard

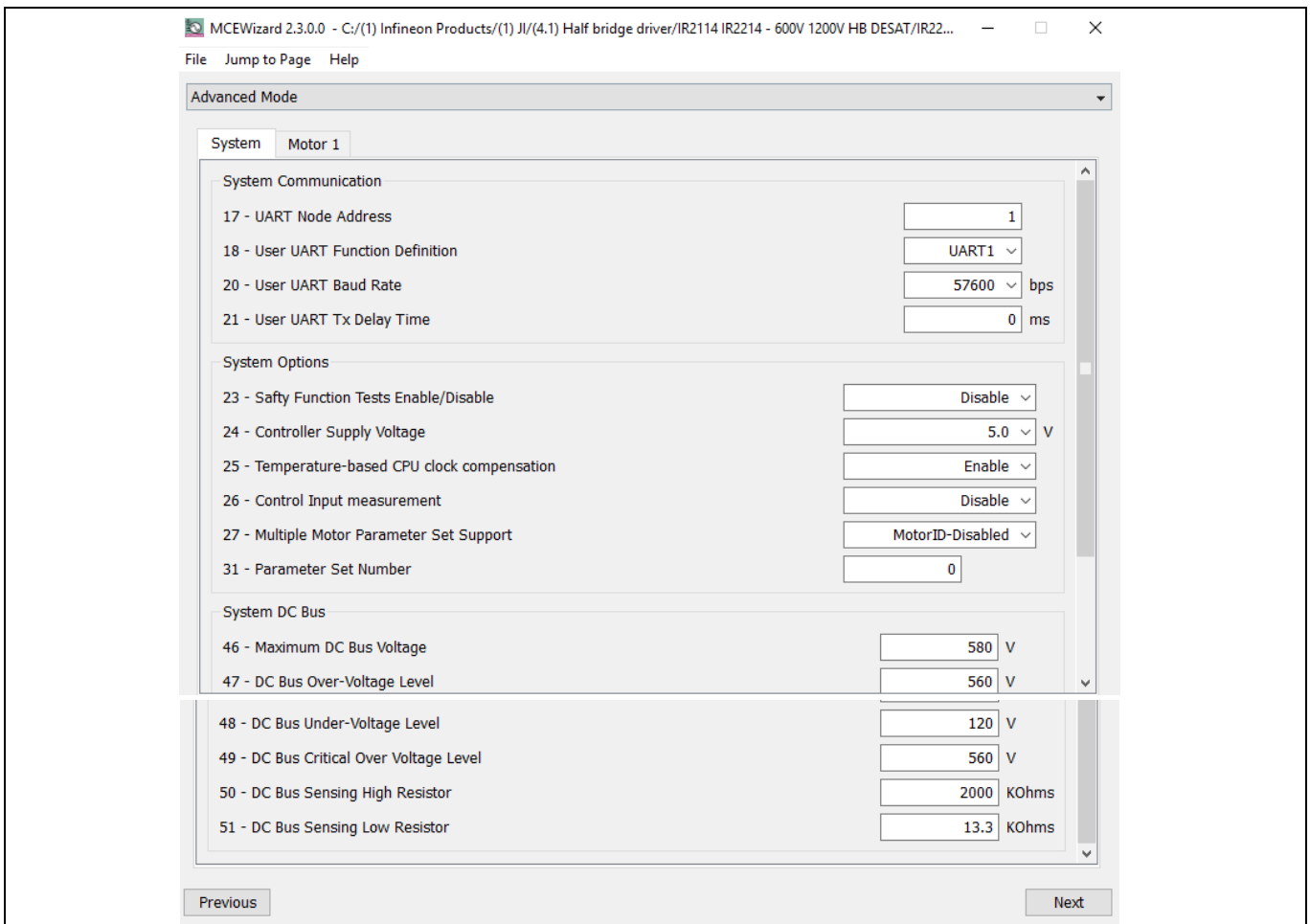


Figure 16 System configuration in MCEWizard

MCEWizard 2.3.0.0 - C:/(1) Infineon Products/(1) JI/(4.1) Half bridge driver/IR2114 IR2214 - 600V 1200V HB DESAT/IR22...

File Jump to Page Help

Advanced Mode

System Motor 1

Motor 1 Motor Parameters

| | |
|----------------------------------|---------------------|
| 1 - Motor Model Name | IdenAge_GK6081 |
| 2 - Motor Rated Amps | 20 Arms |
| 3 - Motor Poles | 6 |
| 4 - Motor Stator Resistance | 0.19 Ohms/phase |
| 5 - Motor Lq Inductance | 2.4 mH |
| 6 - Motor Ld Inductance | 2.2 mH |
| 7 - Motor Back EMF Constant (Ke) | 67.5 V(ln-rms)/krpm |
| 8 - Motor Max RPM | 2500 RPM |
| 9 - Minimum Running Speed | 100 RPM |
| 10 - Speed Ramp Rate | 50 RPM/sec |

Motor 1 Startup Setting

| | |
|-----------------------------------------------------------------|------------|
| 11 - Open Loop Speed Ramp Rate (0 = Disable Open Loop Start-up) | 50 RPM/sec |
| 12 - Parking Time (0= Disable Parking) | 0 sec |
| 13 - Low Speed Threshold | 500 RPM |

14 - Low Speed Current Limit

| | |
|------------------------------|------|
| 14 - Low Speed Current Limit | 20 % |
|------------------------------|------|

Motor 1 Motor Starting

| | |
|----------------------------|---------|
| 15 - Initial Angle Sensing | Disable |
|----------------------------|---------|

Motor 1 Application Information

| | |
|------------------------------------|--------|
| 52 - Motoring Current Limit | 120 % |
| 53 - Regeneration Current Limit | 5 % |
| 54 - Field Weakening Current Limit | 0 % |
| 57 - PG Pulse Per Revolution | 12 PPR |

Motor 1 Regulators

| | |
|------------------------------------------|-------------|
| 58 - Current Regulator Bandwidth | 600 rad/sec |
| 59 - Enable DC Bus Compensation | Enable |
| 60 - Flux Estimator Time Constant | 15 msec |
| 61 - Speed Feedback Filter Time Constant | 0.2 msec |
| 62 - Speed Regulator Proportional Gain | 0.25 |
| 63 - Speed Regulator Integral Gain | 1.4 rad/s |

Motor 1 Fault Conditions

| | |
|---------------------------------------------|---------|
| 68 - Enable DC Bus Overvoltage Fault | Enable |
| 69 - Enable DC Bus Undervoltage Fault | Enable |
| 70 - Flux PLL Out of Control Fault | Disable |
| 71 - Enable Over Temperature Fault | Enable |
| 72 - NTC Over-temperature Voltage Threshold | 1.84 V |
| 73 - Rotor lock Protection Fault | 10-Sec |
| 74 - Enable Phase Loss Fault | Disable |

Motor 1 PWM Information

| | |
|-------------------------|-------------|
| 75 - Over Modulation | Enable |
| 76 - Motor PWM Type | 3Phase_Only |
| 78 - Inverter Dead Time | 1 µsec |

Motor 1 Gate Drive Hardware Setup

| | |
|----------------------------------|--------------|
| 80 - GateSense Low-Side Devices | High is TRUE |
| 81 - GateSense High-Side Devices | High is TRUE |

System and functional description

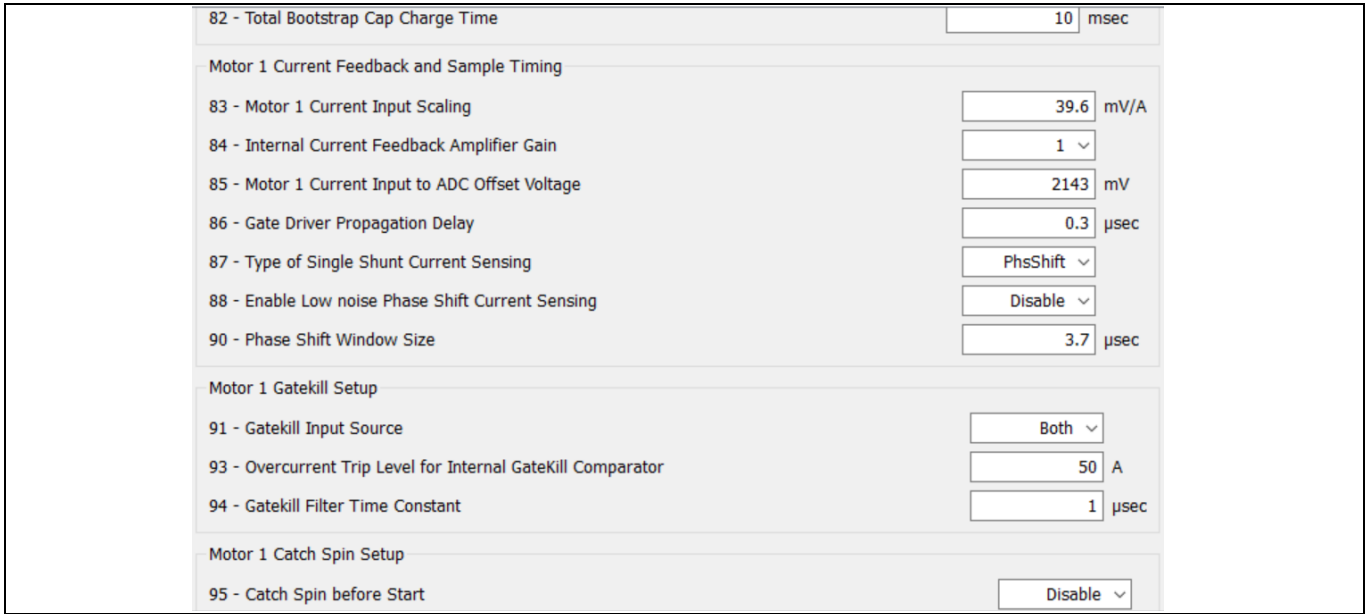


Figure 17 Motor and control algorithm configuration in MCEWizard

2.3.2 MCEDesigner setup

The MCEDesigner is a user interface to access or debug the controller board, see Figure 18.

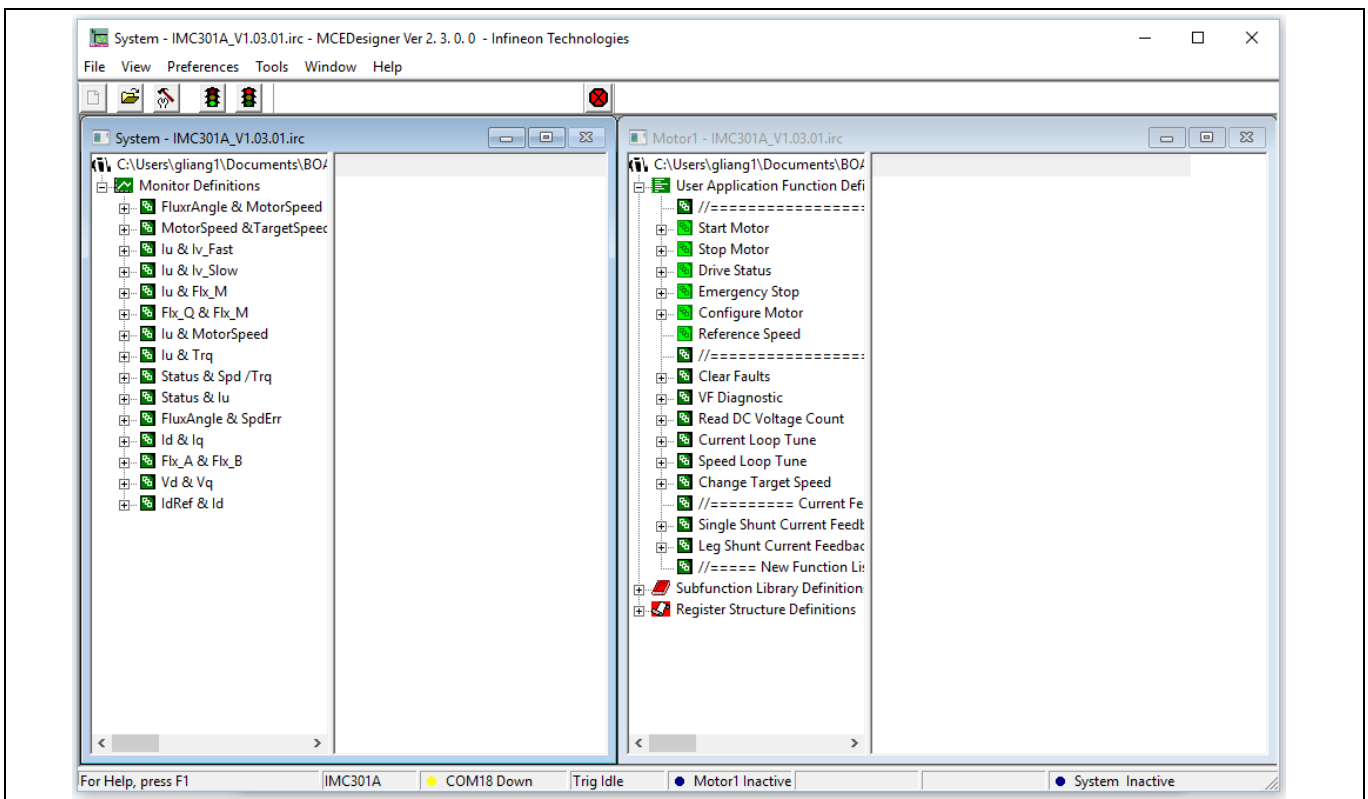


Figure 18 MCEDesigner main display for EVAL-M1-101T

EVAL-M1-IR2214 User Guide

1200 V junction-isolation gate driver IR2214SS evaluation board

System design

3 System design

3.1 Schematics

The schematics of the EVAL-M1-IR2214 are shown in Figure 19 and Figure 20, respectively.

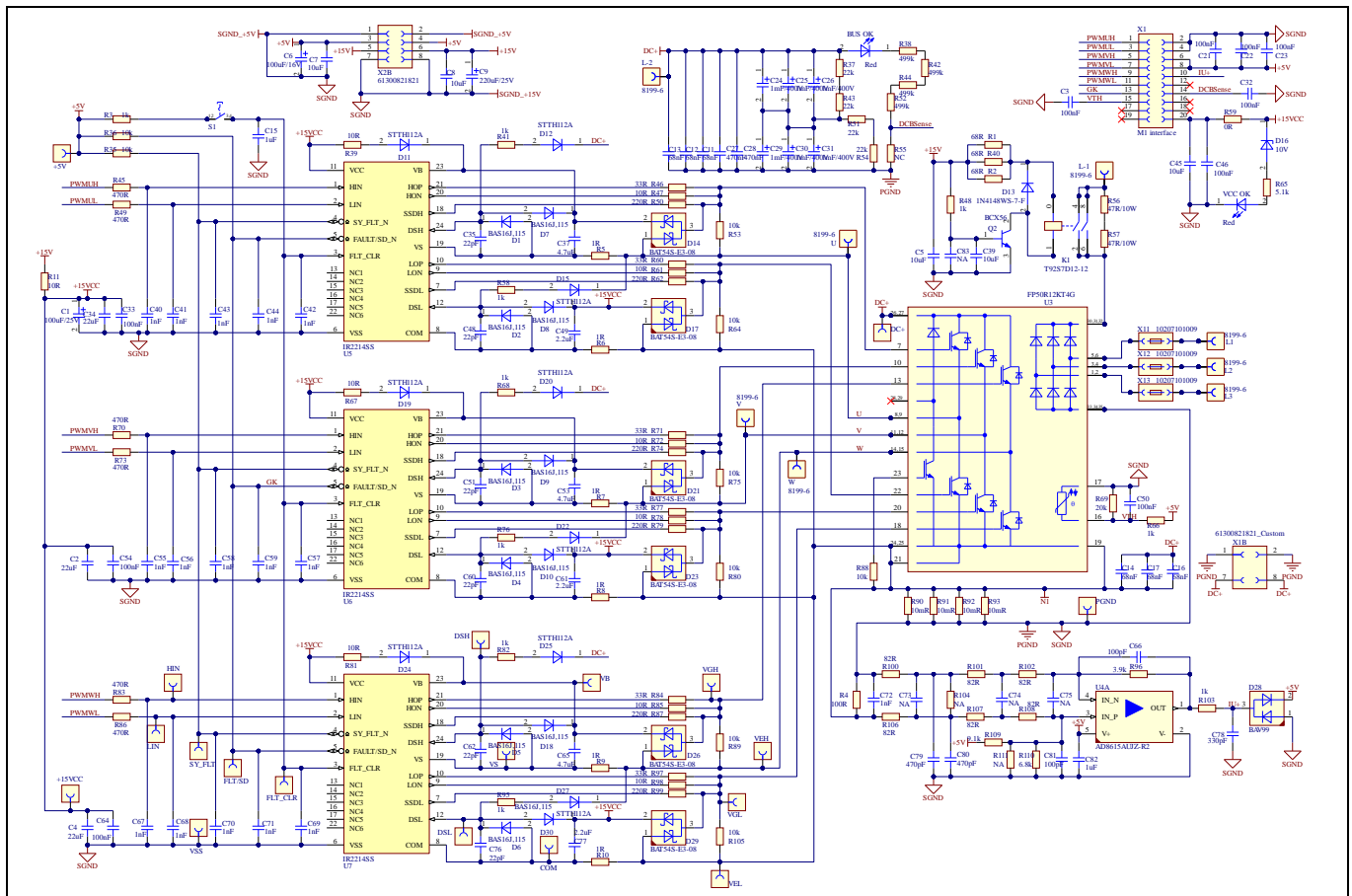


Figure 19 Power circuitry of the EVAL-M1-IR2214

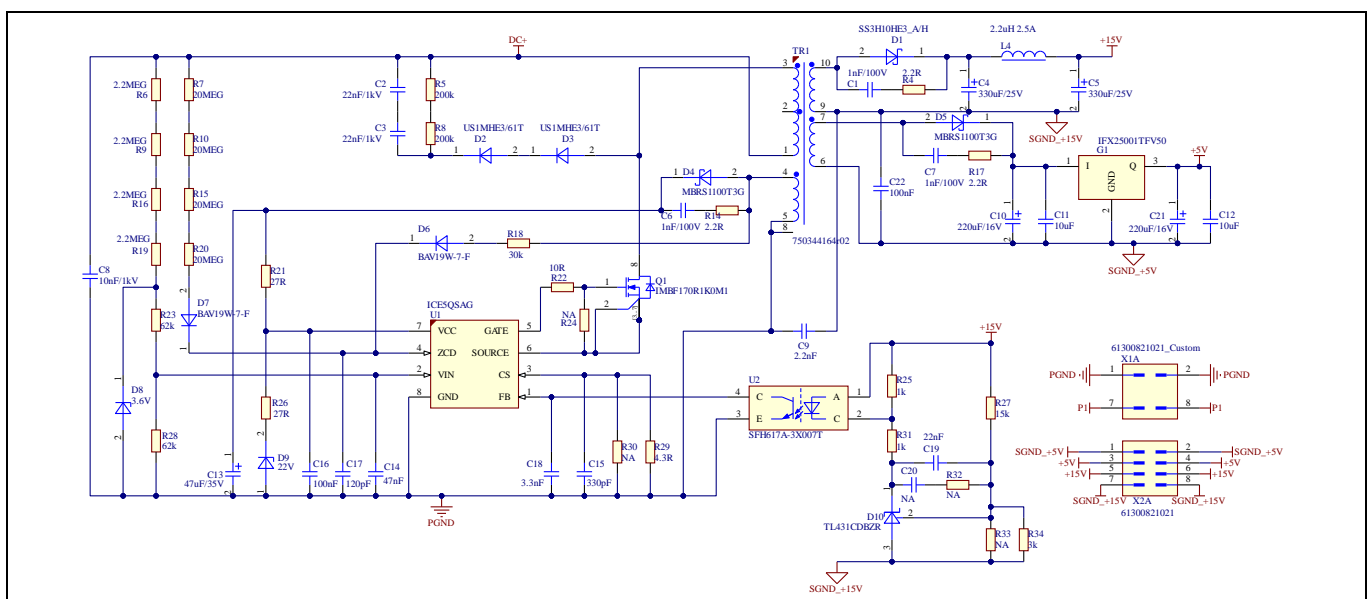


Figure 20 Auxiliary power supply circuitry of the EVAL-M1-IR2214

System design

3.2 Layout

3.2.1 Layout details

The detailed layouts of the EVAL-M1-IR2214 are shown in Figure 21 to Figure 24.

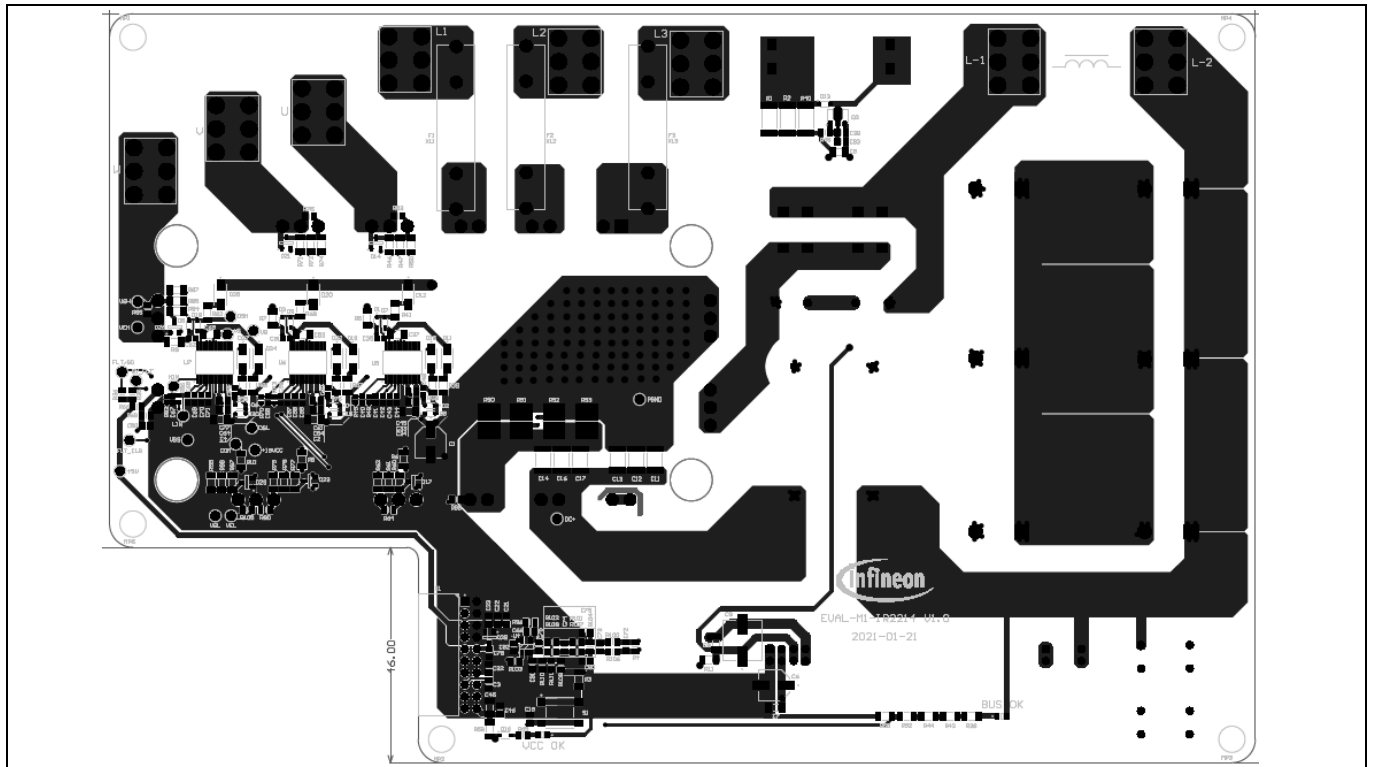


Figure 21 Power circuitry layout of the EVAL-M1-IR2214 - top view

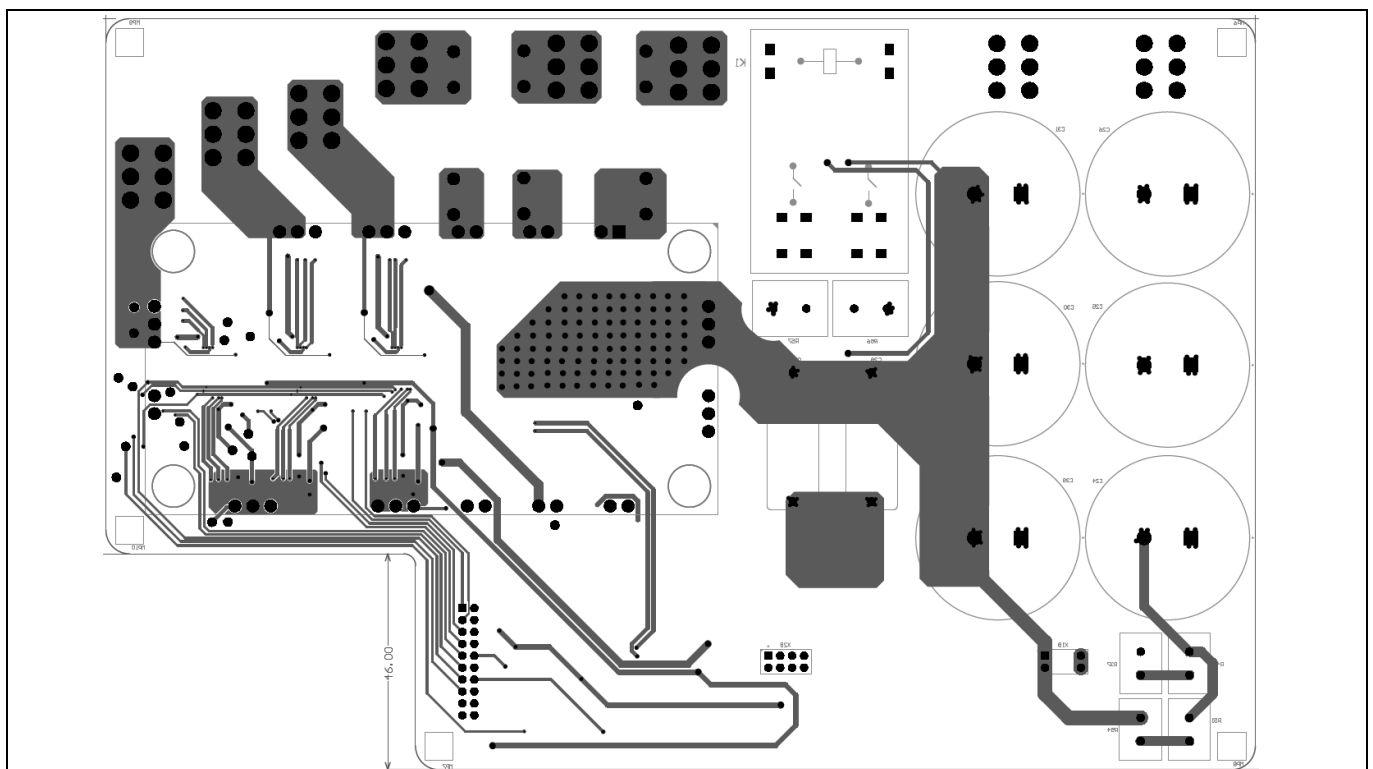


Figure 22 Power circuitry layout of the EVAL-M1-IR2214 - bottom view

System design

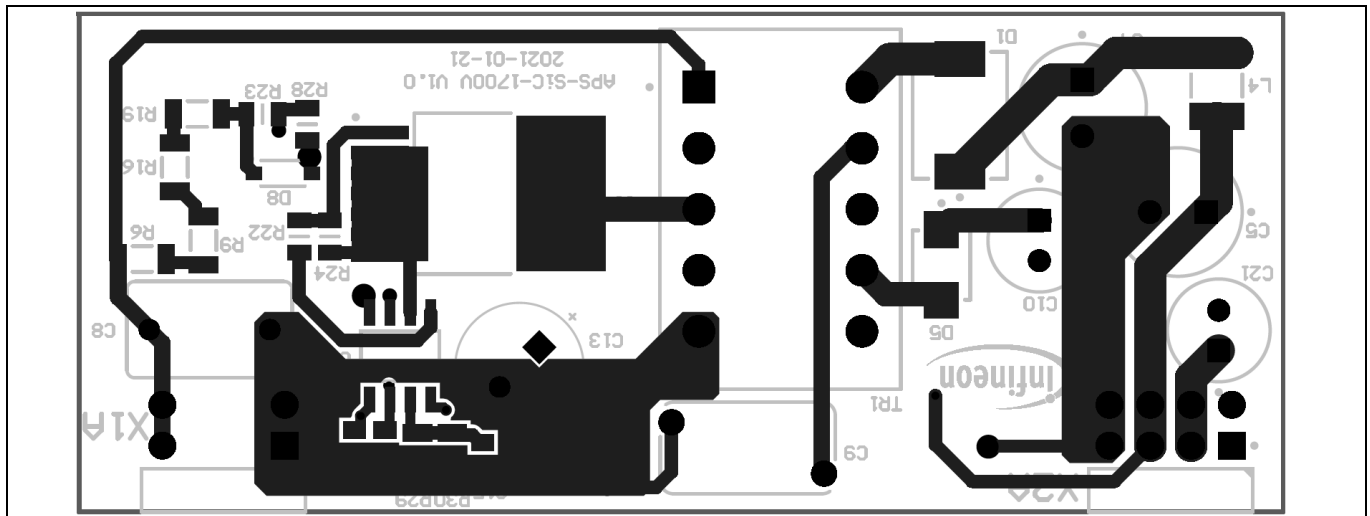


Figure 23 Auxiliary power supply circuitry layout of the EVAL-M1-IR2214 – top view

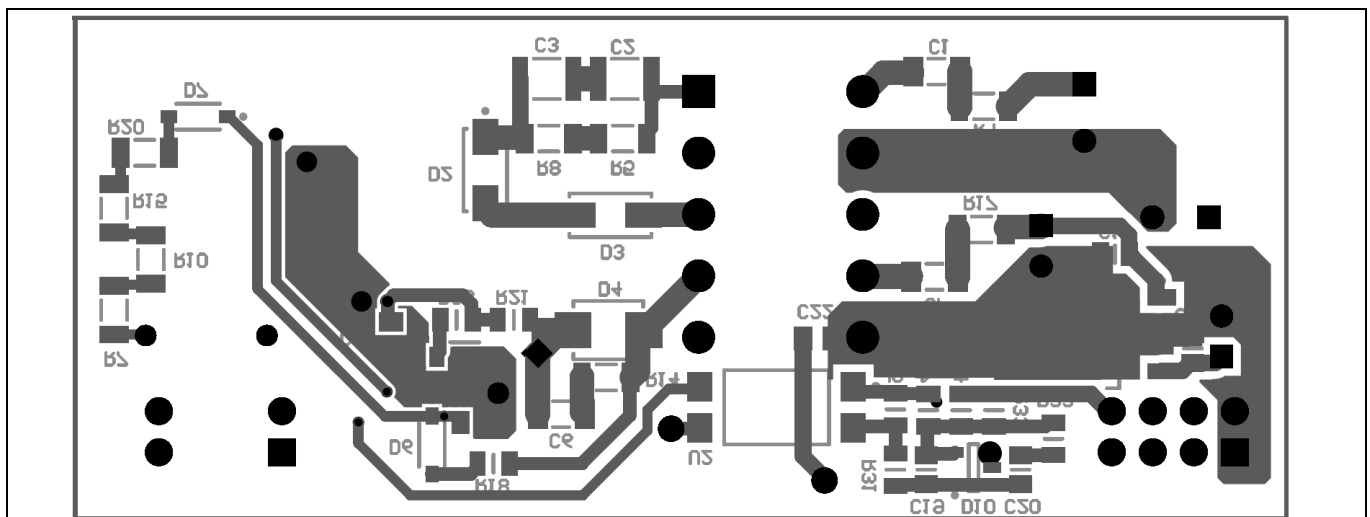


Figure 24 Auxiliary power supply circuitry layout of the EVAL-M1-IR2214 – bottom view

3.2.2 Layout guidelines

Some basic layout guidelines are listed as follows:

- The V_{CC} and V_{BS} bypass capacitors should be close to the IC
- The drive loop should be as small as possible
- The loop of VSS and COM should be as small as possible by connecting the VSS and COM directly at the shunt-resistor terminals
- The two current sensing traces should be started from the shunt terminals and placed close to each other.
- The clearance and creepage should be enough for the 540 V_{DC} bus voltage. In this layout the creepage is set to 5.3 mm which is compliant with the IR2214SS

System design

3.3 Bill of material

The complete bill of material is available on the download section of the Infineon homepage. A log-in is required to download this material.

Table 3 lists the important components used in the EVAL-M1-IR2214.

Table 3 BOM of the most important/critical parts

| No. | Ref designator | Description | Manufacturer | Manufacturer P/N |
|-----|---------------------------------------------------|-------------------------------------------------------------|-----------------------|------------------|
| 1 | U5, U6, U7 | 1200 V half-bridge gate driver with desaturation protection | Infineon Technologies | IR2214SS |
| 2 | U3 | 1200 V/50 A EconoPIM™3 module | Infineon Technologies | FP50R12KT4G |
| 3 | U1 | Quasi-resonant controller | Infineon Technologies | ICE5QSAG |
| 4 | Q1 | 1700 V/1 Ω SiC MOSFET in TO263-7 package | Infineon Technologies | IMBF170R1K0M1 |
| 5 | G1 | 5 V/400 mA linear voltage regulator | Infineon Technologies | IFX25001TFV50 |
| 6 | R90, R91, R92, R93 | 10 m Ω /5 W/1% SMD shunt resistor | Isabellenhuetten | SMT-R010-1.0 |
| 7 | C24, C25, C26, C29, C30, C31 | 400 V/1000 uF/35*60 mm/pitch 10 mm Al E-capacitor | Würth | 861021386035 |
| 8 | U4A | 20 MHz rail-to-rail operational amplifier | ADI | AD8615AUJZ-R2 |
| 9 | RLY1 | Two-pole 30 A/600 V _{AC} PCB mount relay | TE | T92S7D12-12 |
| 10 | D11, D12, D19, D20, D24, D25 | 1200 V ultrafast rectifier | ST | STTH112A |
| 11 | D1, D2, D3, D4, D5, D6, D7, D8, D9, D10, D18, D30 | 75 V/250 mA high-speed switching diode | NXP | BAS16J |
| 12 | R37, R43, R51, R54 | 22 k Ω /5 W/5% vertical resistor | Yageo | SQM500JB-22K |

3.4 Connector details

Table 4 Connectors

| PIN | Label | Function |
|-----|-------|---------------------------------------------|
| | L1 | L1-phase of the power mains |
| | L2 | L2-phase of the power mains |
| | L3 | L3-phase of the power mains |
| | U | U phase-out to the motor |
| | V | V phase-out to the motor |
| | W | W phase-out to the motor |
| | J1 | iMOTION™ MADK-M1 20-pin interface connector |

4 System performance

4.1 Test results running a BLDC motor

The board is tested while running a BLDC motor as in the setup shown in Figure 25.

Test condition:

- Input: 380 Vac
- Phase-out current: 20 A_{rms}
- Room temperature
- BLDC motor: GK6081-6AC31-FE, I_o=20 A, U_i=135 V, test at speed=1200 r/min and 40 Nm
- Heatsink with forced-air cooling for the PIM

Note: After power-on, the pin 5 (FAULT/SD) of IR2214SS is initially in low state, thus disabling the IR2214SS drive output. The users have to press the push-button S1 on the board for 1 second and then release it. This step is necessary to clear the fault status and re-enable the IR2214SS.

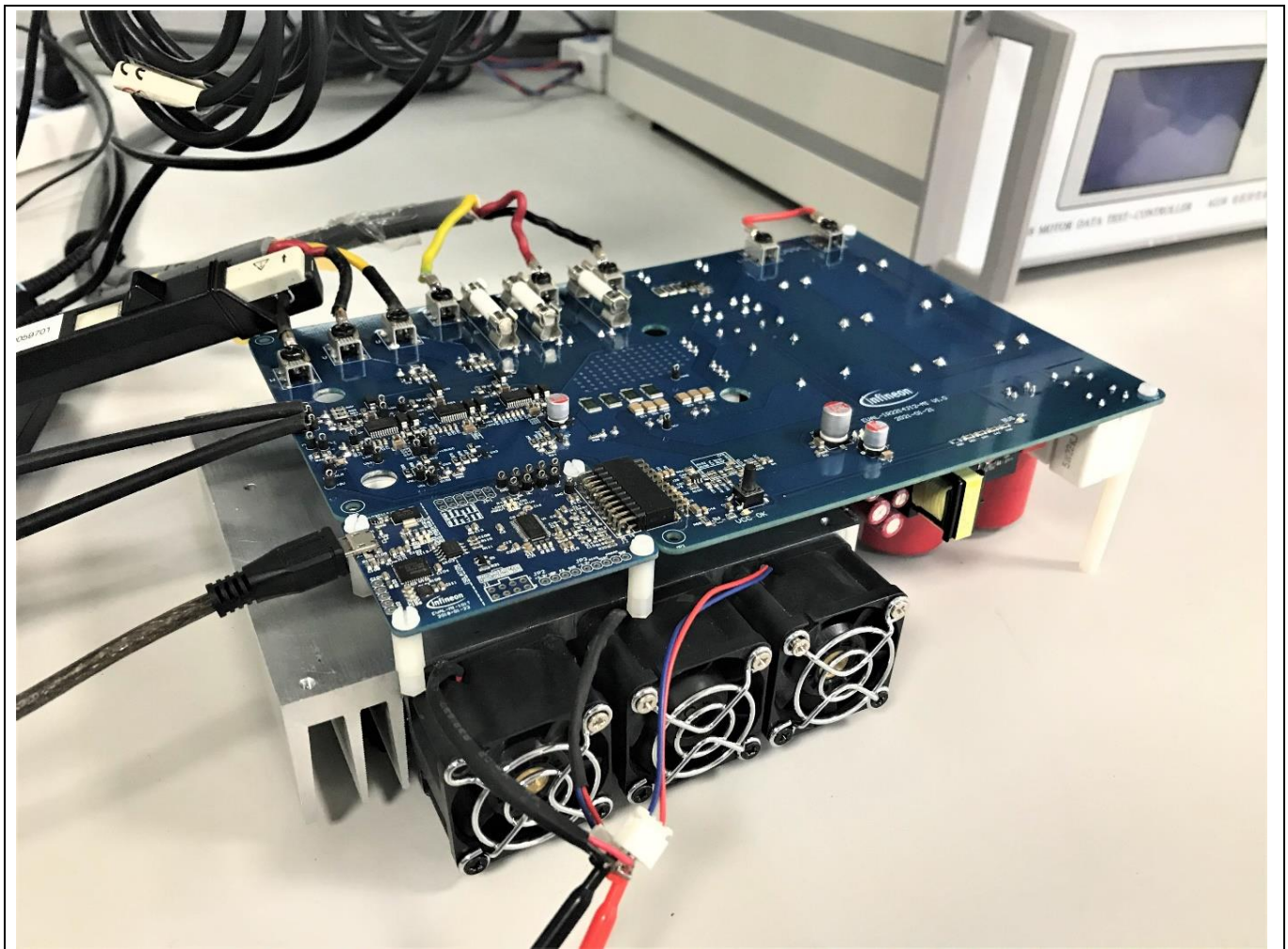


Figure 25 System setup for running a BLDC motor

System performance

Figure 26 shows the waveform when running a BLDC motor. The gate drive signals (V_{GE_HS} , V_{GE_LS}) indicate that no cross-conduction occurred. There are undershoots measured at the low-side desaturation detection pin ‘DSL’ to ‘COM’ (V_{DSL_COM}) while the low-side IGBT is turning ON, however, the undershoots are still within the -3 V limitation in the datasheet.

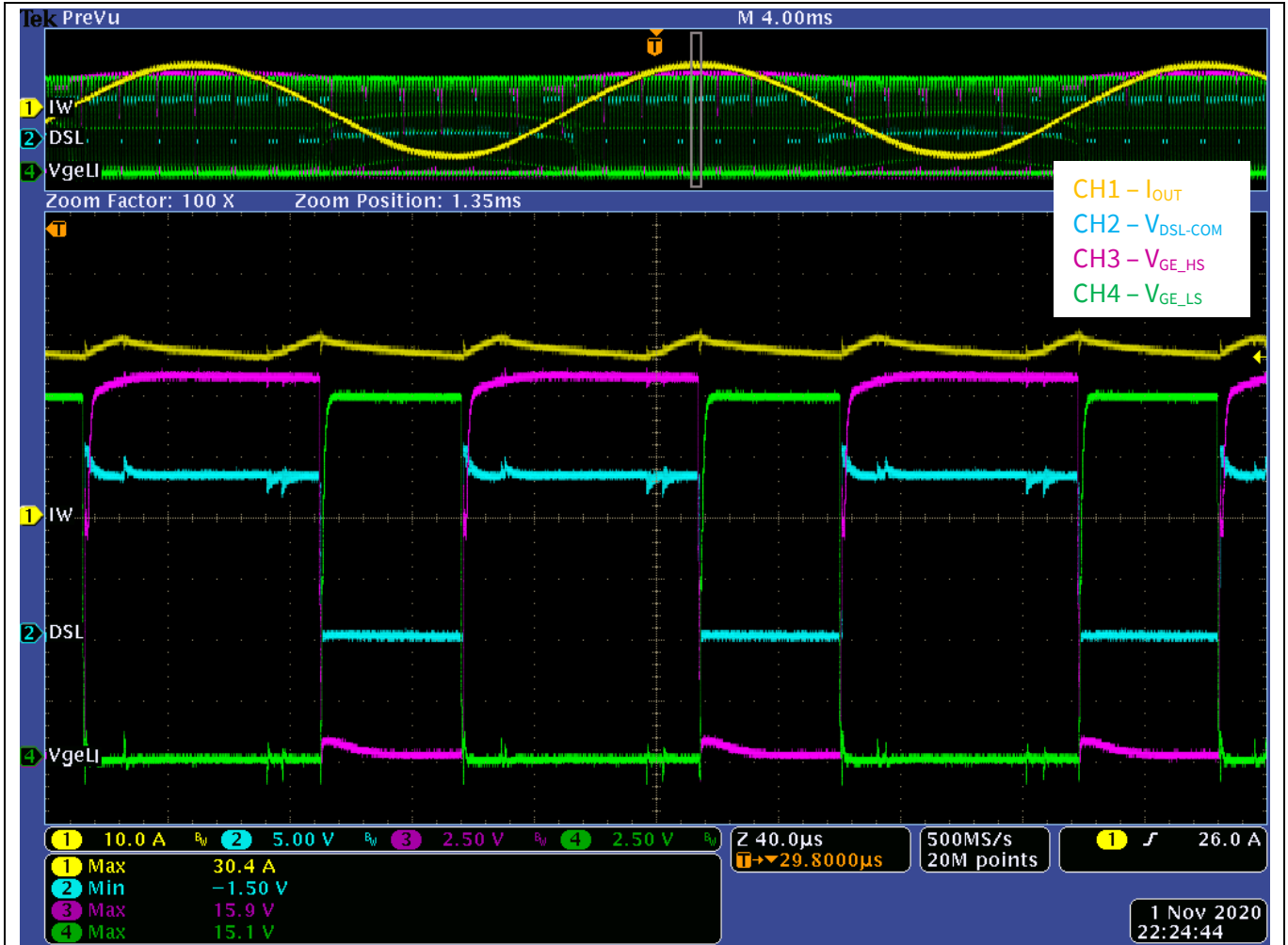


Figure 26 Drive signal waveforms

EVAL-M1-IR2214 User Guide

1200 V junction-isolation gate driver IR2214SS evaluation board

System performance

The desaturation protection is a remarkable feature of the IR2214SS. The W-phase, high-side IGBT is shorted by a short link to verify the short-circuit protection.

From Figure 27, once the desaturation is detected, the gate signal V_{GE_LS} starts to turn off in less than 3 μs . The turn off event is very soft due to the soft over-current shutdown function of the driver. The smooth turn-off prevents the transistor from destruction by over-voltage. The SY_FLT is also pulled low to report a failure of the desaturation which can be read by the other two IR2214SS.

Note: If desaturation is triggered, the users have to press the push-button S1 to re-enable the IR2214SS.

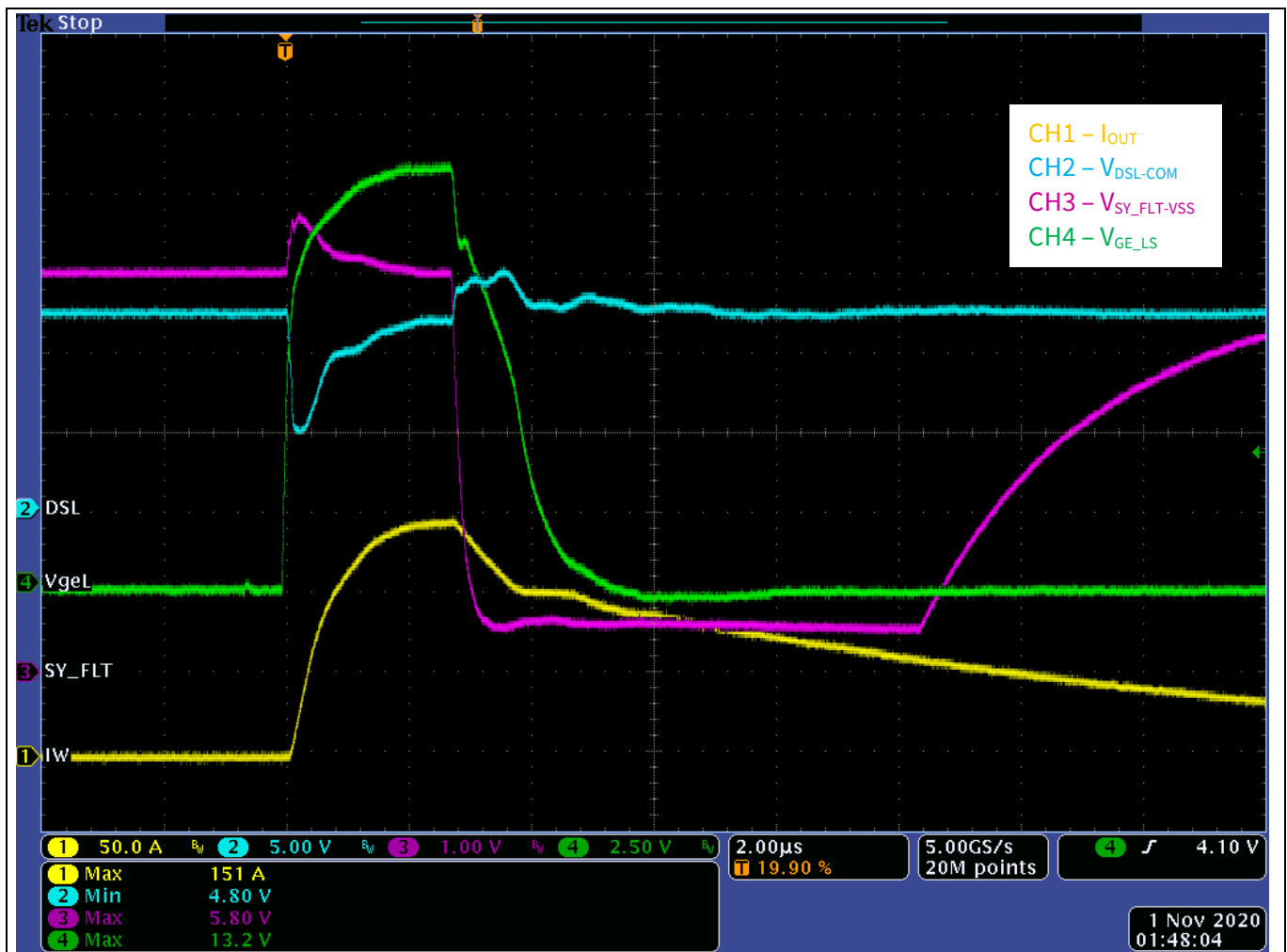


Figure 27 Short-circuit protection

4.2 Test results of the double-pulse test

As in the setup illustrated in section 2.1.2, the double-pulse test is performed to evaluate the board exceeding a 10 kW power rating in a real application.

Test condition:

- Bus voltage: 600 Vdc
- Switching current: 50 A
- Inductor: 200 μ H

Figure 28 shows that the negative V_s and V_{SS} transient referenced to COM are still in the IR2214SS safe-operation area.

Note: 1. To test the worst negative V_s and V_{SS} transient, the inductor is connected between the W-phase mid-point (connector 'W') and ground PGND (test point 'PGND') on the board, and the double-pulse is entered in the HIN.

2. An isolated power supply +15 V should be added externally to power the V_{BS} (connects to the test points 'VB' and 'VS')



Figure 28 Negative V_s and V_{SS} transient at 50 A switching current

5 References and appendices

5.1 Abbreviations and definitions

Table 5 Abbreviations

| Abbreviation | Meaning |
|--------------|-----------------------------------|
| IC | Integrated circuit |
| IGBT | Insulated gate bipolar transistor |
| DC | Direct current |
| AC | Alternating current |
| BLDC | Brushless direct current |
| PIM | Power integrated module |
| SiC | Silicon carbide |
| PWM | Pulse width modulation |
| NTC | Negative temperature coefficient |
| EVAL | Evaluation board |

5.2 References

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- [2] Infineon Technologies AG. Datasheet of FP50R12KT4G (2013) V3.0 [FP50R12KT4G | 1200 V, 50 A PIM three phase input rectifier IGBT module - Infineon Technologies](#)
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- [7] Infineon Technologies AG. MCEDesigner Application Guide (2019) V2.3.0.0 [Semiconductor & System Solutions - Infineon Technologies](#)

Revision history

| Document version | Date of release | Description of changes |
|-------------------------|------------------------|-------------------------------|
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